

## **Material Data Sheet**

## NTC

NTC						Material Data Sheet					
ins B5			ture Sensor ated leads 5*S*								
		27.07	.2022								
IMDS ID if available											
Version 05		05									
Product Part (IMDS: semi component)	S: semi (IMDS: Material)		Material (Classification) VDA 231	Substance			TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic		3B	Mn <sub>3</sub> O <sub>4</sub> NiO Co <sub>3</sub> O <sub>4</sub> Dopants*)	) 3O4			1317-35-7 1313-99-1 1308-06-1	4,5		
Termination	Noble Metal		1D	Ag Glass frit (Pb-B-silio	iss frit (Pb-B-silicate)			7440-22-4	0,5		
Solder	Heavy Metal		1C	Pb Sn Ag				7439-92-1 7440-31-5 7440-22-4	3		
Leads	Heavy Metal		1C	Ni			100	7440-02-0	44		
	Noble Metal		1D	Ag	J		100	7440-22-4	1		
	Thermoplast		2A	PTFE [1] or other thermoplastic	FE [1] or er thermoplastic polymer [2]		100		27		
Encapsulation	Duromer		2D	Ероху		100		20			
			•				•	Sum in total:	100		
sizes [ mm ] Ø2,4 x 50 Ø2,8 x 50	weight ran 0,1	ge [ g ]	part numbers: S861 / S863 [1] S864 [2]					-			
Not Part of a Pi	roduct Cla	ISS									
Contact	Mr. Heinz	einz Strallhofer				Important remarks:					
Division	TPS					<ol> <li>The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated.</li> </ol>					
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\*) others: (not declarable or prohibited substances acc. GADSL)

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\*\*) typical mass percentage of substance

otherwise regulated. This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

2)

## RoHS - Exemptions for the Product Class / Product according to Annex III: ( 🗵 valid 🗆 not valid )

□ no exemptions;

Other Exemption than above

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

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 $\square$  Exemption 6 (b): Lead as an alloying element in aluminum containing up to 0,4 % lead by weight;

 $\hfill\square$  Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;